AMENDMENTS TO THE SPECIFICATION

IN THE SPECIFICATION

[0001] This application is a divisional application of Patent Application Serial-No. 09/541,135, filed March 31, 2000, titled "Method of Forming Scribe Line Planarization Layer[[."]]," issued as U.S. Patent No. 6,383,894.

[0029] Following introduction, masking material 135 is subjected to a photo-definition process. In the example shown in **Figure 4**, masking layer 135 is introduced over the structure to define opening over scribe line areas 115. The structure is then exposed to light source 145, such as an ultraviolet or other light source. The light source transforms a portion of masking material 135, the exposed portion, and ignores the non-exposed portion of masking material 135.